

200g spring force test probe for PCB test

Product information

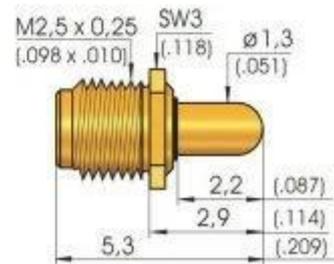
SFENG



SFENG

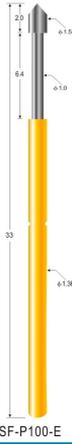


SFENG



Product Name	200g spring force test probe for PCB test
Size	50mil 75mil 100mil or customized pogo pin
Current ration	0-50A
Spring force	customized
Contact resistance	50m Ω

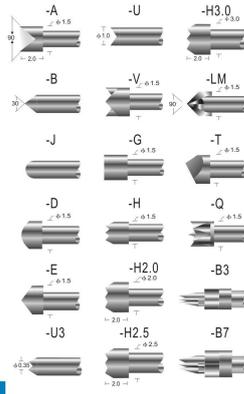
SF-P100



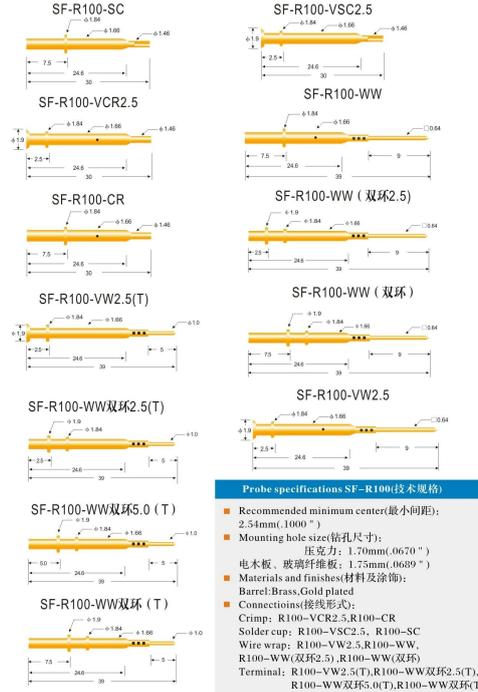
SF-P100-E

Probe specifications SF-P100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(.1000")
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670") 电木板、玻璃纤维板: 1.75mm(.0689")
- Full travel(行程): 6.40(.2520")
- Spring force(弹簧压力): 200g
- Materials and finishes(材料及涂饰): Plunger: Be, Cu, Rh plated; SK4, Rh plated Barrel: Brass, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)



SF-R100



Probe specifications SF-R100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(.1000")
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670") 电木板、玻璃纤维板: 1.75mm(.0689")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R100-VCR2.5, R100-CR Solder cup: R100-VSC2.5, R100-SC Wire wrap: R100-VW2.5, R100-WW, R100-WW(双环2.5), R100-WW(双环) Terminal: R100-VW2.5(T), R100-WW双环2.5(T), R100-WW双环5.0(T), R100-WW双环(T)

Production Flow



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection

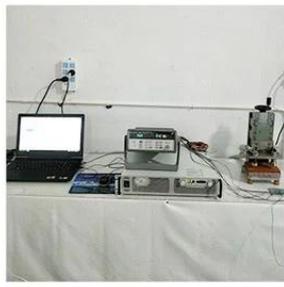


5. Finished products

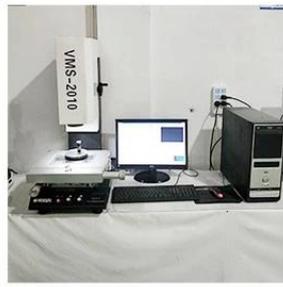


6. Packing

Test Equipment



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

Packaging and Shipment

Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

